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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

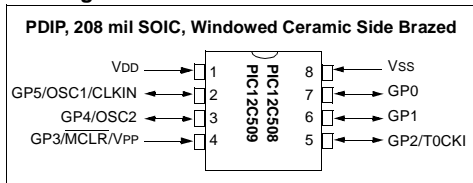
### Applications of "[Embedded - Microcontrollers](#)"

#### Details

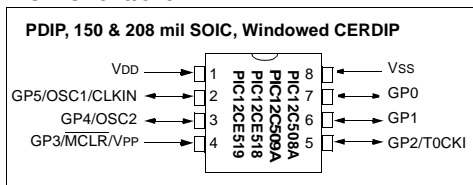
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	5
Program Memory Size	1.5KB (1K x 12)
Program Memory Type	OTP
EEPROM Size	16 x 8
RAM Size	41 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	8-DIP (0.300", 7.62mm)
Supplier Device Package	8-PDIP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic12ce519-04i-p">https://www.e-xfl.com/product-detail/microchip-technology/pic12ce519-04i-p</a>

# PIC12C5XX

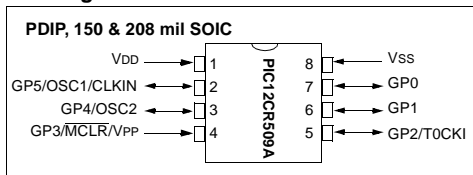
## Pin Diagram - PIC12C508/509



## Pin Diagram - PIC12C508A/509A, PIC12CE518/519



## Pin Diagram - PIC12CR509A



## Device Differences

Device	Voltage Range	Oscillator	Oscillator Calibration <sup>2</sup> (Bits)	Process Technology (Microns)
PIC12C508A	3.0-5.5	See Note 1	6	0.7
PIC12LC508A	2.5-5.5	See Note 1	6	0.7
PIC12C508	2.5-5.5	See Note 1	4	0.9
PIC12C509A	3.0-5.5	See Note 1	6	0.7
PIC12LC509A	2.5-5.5	See Note 1	6	0.7
PIC12C509	2.5-5.5	See Note 1	4	0.9
PIC12CR509A	2.5-5.5	See Note 1	6	0.7
PIC12CE518	3.0-5.5	-	6	0.7
PIC12LCE518	2.5-5.5	-	6	0.7
PIC12CE519	3.0-5.5	-	6	0.7
PIC12LCE519	2.5-5.5	-	6	0.7

**Note 1:** If you change from the PIC12C50X to the PIC12C50XA or to the PIC12CR50XA, please verify oscillator characteristics in your application.

**Note 2:** See Section 7.2.5 for OSCCAL implementation differences.

## 2.0 PIC12C5XX DEVICE VARIETIES

A variety of packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in this section. When placing orders, please use the PIC12C5XX Product Identification System at the back of this data sheet to specify the correct part number.

### 2.1 UV Erasable Devices

The UV erasable version, offered in ceramic side brazed package, is optimal for prototype development and pilot programs.

The UV erasable version can be erased and reprogrammed to any of the configuration modes.

**Note:** Please note that erasing the device will also erase the pre-programmed internal calibration value for the internal oscillator. The calibration value must be saved prior to erasing the part.

Microchip's PICSTART® PLUS and PRO MATE® programmers all support programming of the PIC12C5XX. Third party programmers also are available; refer to the *Microchip Third Party Guide* for a list of sources.

### 2.2 One-Time-Programmable (OTP) Devices

The availability of OTP devices is especially useful for customers who need the flexibility for frequent code updates or small volume applications.

The OTP devices, packaged in plastic packages permit the user to program them once. In addition to the program memory, the configuration bits must also be programmed.

### 2.3 Quick-Turnaround-Production (QTP) Devices

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and fuse options already programmed by the factory. Certain code and prototype verification procedures do apply before production shipments are available. Please contact your local Microchip Technology sales office for more details.

### 2.4 Serialized Quick-Turnaround Production (SQTP<sup>SM</sup>) Devices

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number which can serve as an entry-code, password or ID number.

### 2.5 Read Only Memory (ROM) Device

Microchip offers masked ROM to give the customer a low cost option for high volume, mature products.

## 3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC12C5XX family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC12C5XX uses a Harvard architecture in which program and data are accessed on separate buses. This improves bandwidth over traditional von Neumann architecture where program and data are fetched on the same bus. Separating program and data memory further allows instructions to be sized differently than the 8-bit wide data word. Instruction opcodes are 12-bits wide making it possible to have all single word instructions. A 12-bit wide program memory access bus fetches a 12-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions (33) execute in a single cycle (1 $\mu$ s @ 4MHz) except for program branches.

The table below lists program memory (EPROM), data memory (RAM), ROM memory, and non-volatile (EEPROM) for each device.

Device	Memory			
	EPROM Program	ROM Program	RAM Data	EEPROM Data
PIC12C508	512 x 12		25	
PIC12C509	1024 x 12		41	
PIC12C508A	512 x 12		25	
PIC12C509A	1024 x 12		41	
PIC12CR509A		1024 x 12	41	
PIC12CE518	512 x 12		25 x 8	16 x 8
PIC12CE519	1024 x 12		41 x 8	16 x 8

The PIC12C5XX can directly or indirectly address its register files and data memory. All special function registers including the program counter are mapped in the data memory. The PIC12C5XX has a highly orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC12C5XX simple yet efficient. In addition, the learning curve is reduced significantly.

The PIC12C5XX device contains an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the W (working) register. The other operand is either a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow and digit borrow out bit, respectively, in subtraction. See the SUBWF and ADDWF instructions for examples.

A simplified block diagram is shown in Figure 3-1, with the corresponding device pins described in Table 3-1.

## 4.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral functions to control the operation of the device (Table 4-1).

The special registers can be classified into two sets. The special function registers associated with the “core” functions are described in this section. Those related to the operation of the peripheral features are described in the section for each peripheral feature.

**TABLE 4-1: SPECIAL FUNCTION REGISTER (SFR) SUMMARY**

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-On Reset	Value on All Other Resets <sup>(2)</sup>
N/A	TRIS	—	—							--11 1111	--11 1111
N/A	OPTION	Contains control bits to configure Timer0, Timer0/WDT prescaler, wake-up on change, and weak pull-ups								1111 1111	1111 1111
00h	INDF	Uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	uuuu uuuu
01h	TMR0	8-bit real-time clock/counter								xxxx xxxx	uuuu uuuu
02h <sup>(1)</sup>	PCL	Low order 8 bits of PC								1111 1111	1111 1111
03h	STATUS	GPWUF	—	PA0	T0	PD	Z	DC	C	0001 1xxx	q00q quuu <sup>(3)</sup>
04h	FSR (PIC12C508/ PIC12C508A/ PIC12C518)	Indirect data memory address pointer								111x xxxx	111u uuuu
04h	FSR (PIC12C509/ PIC12C509A/ PIC12CR509A/ PIC12CE519)	Indirect data memory address pointer								110x xxxx	11uu uuuu
05h	OSCCAL (PIC12C508/ PIC12C509)	CAL3	CAL2	CAL1	CAL0	—	—	—	—	0111 ----	uuuu ----
05h	OSCCAL (PIC12C508A/ PIC12C509A/ PIC12CE518/ PIC12CE519/ PIC12CR509A)	CAL5	CAL4	CAL3	CAL2	CAL1	CAL0	—	—	1000 00--	uuuu uu--
06h	GPIO (PIC12C508/ PIC12C509/ PIC12C508A/ PIC12C509A/ PIC12CR509A)	—	—	GP5	GP4	GP3	GP2	GP1	GP0	--xx xxxx	--uu uuuu
06h	GPIO (PIC12CE518/ PIC12CE519)	SCL	SDA	GP5	GP4	GP3	GP2	GP1	GP0	11xx xxxx	11uu uuuu

Legend: Shaded boxes = unimplemented or unused, — = unimplemented, read as '0' (if applicable)

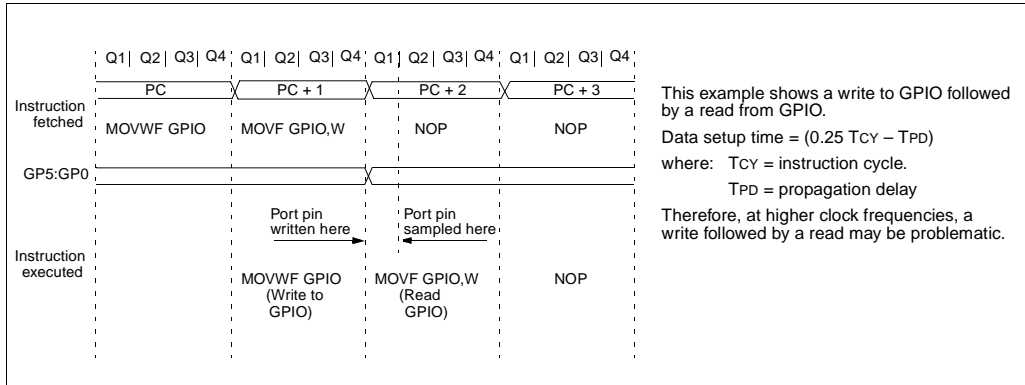
x = unknown, u = unchanged, q = see the tables in Section 8.7 for possible values.

Note 1: The upper byte of the Program Counter is not directly accessible. See Section 4.6 for an explanation of how to access these bits.

2: Other (non power-up) resets include external reset through  $\overline{\text{MCLR}}$ , watchdog timer and wake-up on pin change reset.

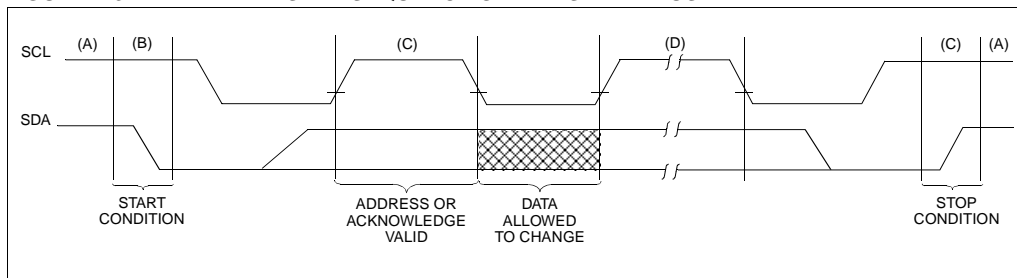
3: If reset was due to wake-up on pin change then bit 7 = 1. All other resets will cause bit 7 = 0.

**FIGURE 5-2: SUCCESSIVE I/O OPERATION**

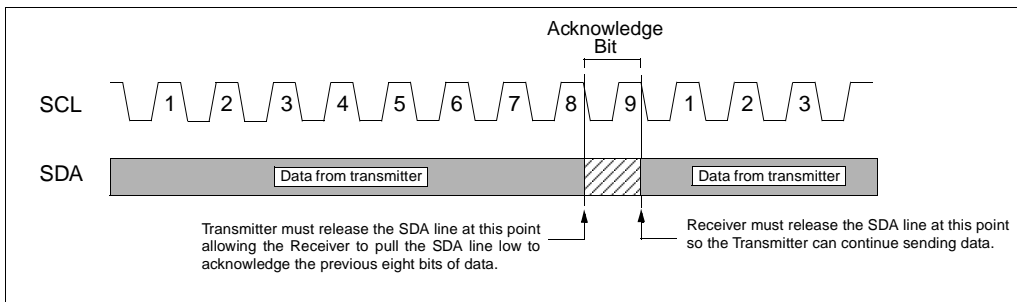


NOTES:

**FIGURE 7-3: DATA TRANSFER SEQUENCE ON THE SERIAL BUS**



**FIGURE 7-4: ACKNOWLEDGE TIMING**

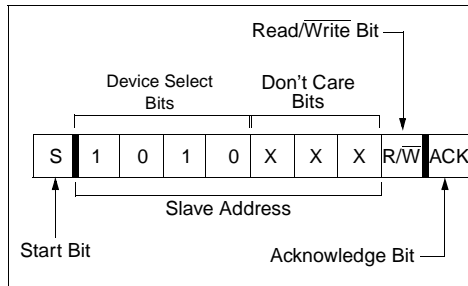


## 7.2 Device Addressing

After generating a START condition, the bus master transmits a control byte consisting of a slave address and a Read/Write bit that indicates what type of operation is to be performed. The slave address consists of a 4-bit device code (1010) followed by three don't care bits.

The last bit of the control byte determines the operation to be performed. When set to a one a read operation is selected, and when set to a zero a write operation is selected. (Figure 7-5). The bus is monitored for its corresponding slave address all the time. It generates an acknowledge bit if the slave address was true and it is not in a programming mode.

**FIGURE 7-5: CONTROL BYTE FORMAT**





## 8.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits to deal with the needs of real-time applications. The PIC12C5XX family of microcontrollers has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These features are:

- Oscillator selection
- Reset
  - Power-On Reset (POR)
  - Device Reset Timer (DRT)
  - Wake-up from SLEEP on pin change
- Watchdog Timer (WDT)
- SLEEP
- Code protection
- ID locations
- In-circuit Serial Programming

The PIC12C5XX has a Watchdog Timer which can be shut off only through configuration bit WDTE. It runs off of its own RC oscillator for added reliability. If using XT or LP selectable oscillator options, there is always an 18 ms (nominal) delay provided by the Device Reset Timer (DRT), intended to keep the chip in reset until the crystal oscillator is stable. If using INTRC or EXTRC there is an 18 ms delay only on VDD power-up. With this timer on-chip, most applications need no external reset circuitry.

The SLEEP mode is designed to offer a very low current power-down mode. The user can wake-up from SLEEP through a change on input pins or through a Watchdog Timer time-out. Several oscillator options are also made available to allow the part to fit the application, including an internal 4 MHz oscillator. The EXTRC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

### 8.1 Configuration Bits

The PIC12C5XX configuration word consists of 12 bits. Configuration bits can be programmed to select various device configurations. Two bits are for the selection of the oscillator type, one bit is the Watchdog Timer enable bit, and one bit is the MCLR enable bit.

**FIGURE 8-1: CONFIGURATION WORD FOR PIC12C5XX**

—	—	—	—	—	—	—	MCLRE	CP	WDTE	FOSC1	FOSC0	Register: CONFIG
bit11	10	9	8	7	6	5	4	3	2	1	bit0	Address <sup>(1)</sup> : FFFh
bit 11-5: <b>Unimplemented</b>												
bit 4: <b>MCLRE:</b> MCLR enable bit.												
1 = MCLR pin enabled												
0 = MCLR tied to VDD, (Internally)												
bit 3: <b>CP:</b> Code protection bit.												
1 = Code protection off												
0 = Code protection on												
bit 2: <b>WDTE:</b> Watchdog timer enable bit												
1 = WDT enabled												
0 = WDT disabled												
bit 1-0: <b>FOSC1:FOSC0:</b> Oscillator selection bits												
11 = EXTRC - external RC oscillator												
10 = INTRC - internal RC oscillator												
01 = XT oscillator												
00 = LP oscillator												
Note 1: Refer to the PIC12C5XX Programming Specifications to determine how to access the configuration word. This register is not user addressable during device operation.												

## 8.2 Oscillator Configurations

### 8.2.1 OSCILLATOR TYPES

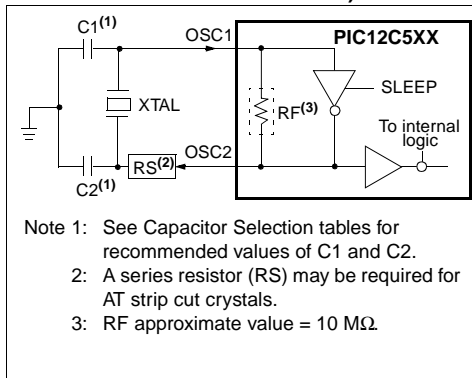
The PIC12C5XX can be operated in four different oscillator modes. The user can program two configuration bits (FOSC1:FOSC0) to select one of these four modes:

- LP: Low Power Crystal
- XT: Crystal/Resonator
- INTRC: Internal 4 MHz Oscillator
- EXTRC: External Resistor/Capacitor

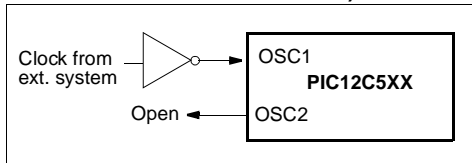
### 8.2.2 CRYSTAL OSCILLATOR / CERAMIC RESONATORS

In XT or LP modes, a crystal or ceramic resonator is connected to the GP5/OSC1/CLKIN and GP4/OSC2 pins to establish oscillation (Figure 8-2). The PIC12C5XX oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT or LP modes, the device can have an external clock source drive the GP5/OSC1/CLKIN pin (Figure 8-3).

**FIGURE 8-2: CRYSTAL OPERATION (OR CERAMIC RESONATOR) (XT OR LP OSC CONFIGURATION)**



**FIGURE 8-3: EXTERNAL CLOCK INPUT OPERATION (XT OR LP OSC CONFIGURATION)**



**TABLE 8-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS - PIC12C5XX**

Osc Type	Resonator Freq	Cap. Range C1	Cap. Range C2
XT	4.0 MHz	30 pF	30 pF

These values are for design guidance only. Since each resonator has its own characteristics, the user should consult the resonator manufacturer for appropriate values of external components.

**TABLE 8-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR - PIC12C5XX**

Osc Type	Resonator Freq	Cap. Range C1	Cap. Range C2
LP	32 kHz <sup>(1)</sup>	15 pF	15 pF
XT	200 kHz	47-68 pF	47-68 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF

Note 1: For VDD > 4.5V, C1 = C2 ≈ 30 pF is recommended.

These values are for design guidance only. Rs may be required to avoid overdriving crystals with low drive level specification. Since each crystal has its own characteristics, the user should consult the crystal manufacturer for appropriate values of external components.

## 8.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a prepackaged oscillator or a simple oscillator circuit with TTL gates can be used as an external crystal oscillator circuit. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used: one with parallel resonance, or one with series resonance.

Figure 8-4 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180-degree phase shift that a parallel oscillator requires. The 4.7 k $\Omega$  resistor provides the negative feedback for stability. The 10 k $\Omega$  potentiometers bias the 74AS04 in the linear region. This circuit could be used for external oscillator designs.

**FIGURE 8-4: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT**

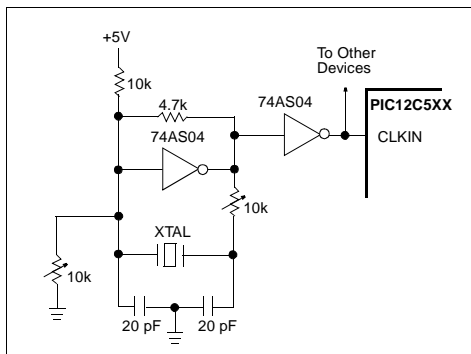
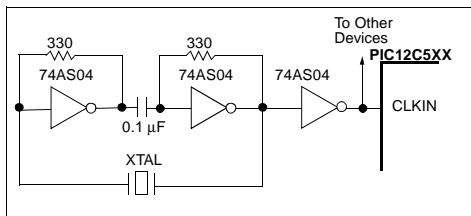


Figure 8-5 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180-degree phase shift in a series resonant oscillator circuit. The 330  $\Omega$  resistors provide the negative feedback to bias the inverters in their linear region.

**FIGURE 8-5: EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT**



## 8.2.4 EXTERNAL RC OSCILLATOR

For timing insensitive applications, the RC device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (R<sub>ext</sub>) and capacitor (C<sub>ext</sub>) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low C<sub>ext</sub> values. The user also needs to take into account variation due to tolerance of external R and C components used.

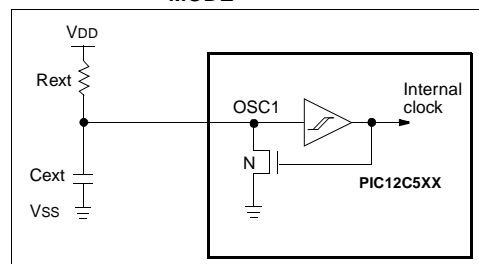
Figure 8-6 shows how the R/C combination is connected to the PIC12C5XX. For R<sub>ext</sub> values below 2.2 k $\Omega$ , the oscillator operation may become unstable, or stop completely. For very high R<sub>ext</sub> values (e.g., 1 M $\Omega$ ) the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend keeping R<sub>ext</sub> between 3 k $\Omega$  and 100 k $\Omega$ .

Although the oscillator will operate with no external capacitor (C<sub>ext</sub> = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

The Electrical Specifications sections show RC frequency variation from part to part due to normal process variation. The variation is larger for larger R (since leakage current variation will affect RC frequency more for large R) and for smaller C (since variation of input capacitance will affect RC frequency more).

Also, see the Electrical Specifications sections for variation of oscillator frequency due to V<sub>DD</sub> for given R<sub>ext</sub>/C<sub>ext</sub> values as well as frequency variation due to operating temperature for given R, C, and V<sub>DD</sub> values.

**FIGURE 8-6: EXTERNAL RC OSCILLATOR MODE**



## 8.7 Time-Out Sequence, Power Down, and Wake-up from SLEEP Status Bits (TO/PD/GPWUF)

The  $\overline{TO}$ ,  $\overline{PD}$ , and GPWUF bits in the STATUS register can be tested to determine if a RESET condition has been caused by a power-up condition, a  $\overline{MCLR}$  or Watchdog Timer (WDT) reset.

**TABLE 8-7:  $\overline{TO}/\overline{PD}/\overline{GPWUF}$  STATUS AFTER RESET**

GPWUF	$\overline{TO}$	$\overline{PD}$	RESET caused by
0	0	0	WDT wake-up from SLEEP
0	0	u	WDT time-out (not from SLEEP)
0	1	0	$\overline{MCLR}$ wake-up from SLEEP
0	1	1	Power-up
0	u	u	$\overline{MCLR}$ not during SLEEP
1	1	0	Wake-up from SLEEP on pin change

Legend: u = unchanged

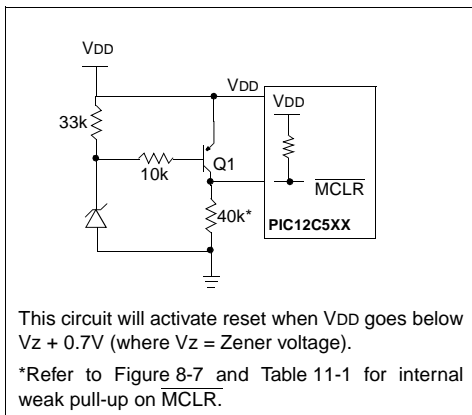
Note 1: The  $\overline{TO}$ ,  $\overline{PD}$ , and GPWUF bits maintain their status (u) until a reset occurs. A low-pulse on the  $\overline{MCLR}$  input does not change the  $\overline{TO}$ ,  $\overline{PD}$ , and GPWUF status bits.

## 8.8 Reset on Brown-Out

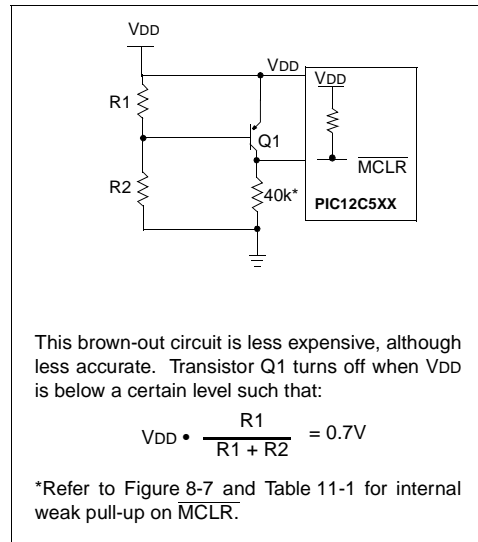
A brown-out is a condition where device power ( $V_{DD}$ ) dips below its minimum value, but not to zero, and then recovers. The device should be reset in the event of a brown-out.

To reset PIC12C5XX devices when a brown-out occurs, external brown-out protection circuits may be built, as shown in Figure 8-13, Figure 8-14 and Figure 8-15

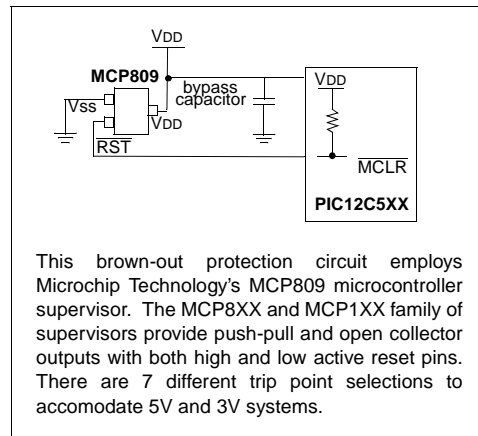
**FIGURE 8-13: BROWN-OUT PROTECTION CIRCUIT 1**



**FIGURE 8-14: BROWN-OUT PROTECTION CIRCUIT 2**



**FIGURE 8-15: BROWN-OUT PROTECTION CIRCUIT 3**



## COMF Complement f

**Syntax:** [ *label* ] COMF f,d

**Operands:**  $0 \leq f \leq 31$   
 $d \in [0,1]$

**Operation:**  $(\bar{f}) \rightarrow (\text{dest})$

**Status Affected:** Z

**Encoding:**

0010	01df	ffff
------	------	------

**Description:** The contents of register 'f' are complemented. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

**Words:** 1

**Cycles:** 1

**Example:** COMF REG1, 0

Before Instruction  
 REG1 = 0x13

After Instruction  
 REG1 = 0x13  
 W = 0xEC

## DECf Decrement f

**Syntax:** [ *label* ] DECf f,d

**Operands:**  $0 \leq f \leq 31$   
 $d \in [0,1]$

**Operation:**  $(f) - 1 \rightarrow (\text{dest})$

**Status Affected:** Z

**Encoding:**

0000	11df	ffff
------	------	------

**Description:** Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

**Words:** 1

**Cycles:** 1

**Example:** DECf CNT, 1

Before Instruction  
 CNT = 0x01  
 Z = 0

After Instruction  
 CNT = 0x00  
 Z = 1

## DECFSZ Decrement f, Skip if 0

**Syntax:** [ *label* ] DECFSZ f,d

**Operands:**  $0 \leq f \leq 31$   
 $d \in [0,1]$

**Operation:**  $(f) - 1 \rightarrow d$ ; skip if result = 0

**Status Affected:** None

**Encoding:**

0010	11df	ffff
------	------	------

**Description:** The contents of register 'f' are decremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.  
 If the result is 0, the next instruction, which is already fetched, is discarded and an NOP is executed instead making it a two cycle instruction.

**Words:** 1

**Cycles:** 1(2)

**Example:**

```

HERE    DECFSZ  CNT, 1
        GOTO    LOOP
        CONTINUE
        .
        .
        .
  
```

Before Instruction  
 PC = address (HERE)

After Instruction  
 CNT = CNT - 1;  
 if CNT = 0,  
 PC = address (CONTINUE);  
 if CNT  $\neq$  0,  
 PC = address (HERE+1)

## GOTO Unconditional Branch

**Syntax:** [ *label* ] GOTO k

**Operands:**  $0 \leq k \leq 511$

**Operation:**  $k \rightarrow \text{PC}<8:0>$ ;  
 $\text{STATUS}<6:5> \rightarrow \text{PC}<10:9>$

**Status Affected:** None

**Encoding:**

101k	kkkk	kkkk
------	------	------

**Description:** GOTO is an unconditional branch. The 9-bit immediate value is loaded into PC bits <8:0>. The upper bits of PC are loaded from STATUS<6:5>. GOTO is a two cycle instruction.

**Words:** 1

**Cycles:** 2

**Example:** GOTO THERE

After Instruction  
 PC = address (THERE)

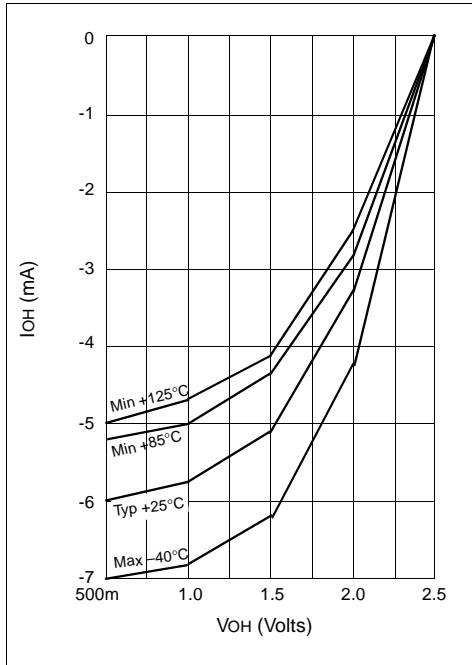
# PIC12C5XX

**TABLE 11-1: PULL-UP RESISTOR RANGES - PIC12C508/C509**

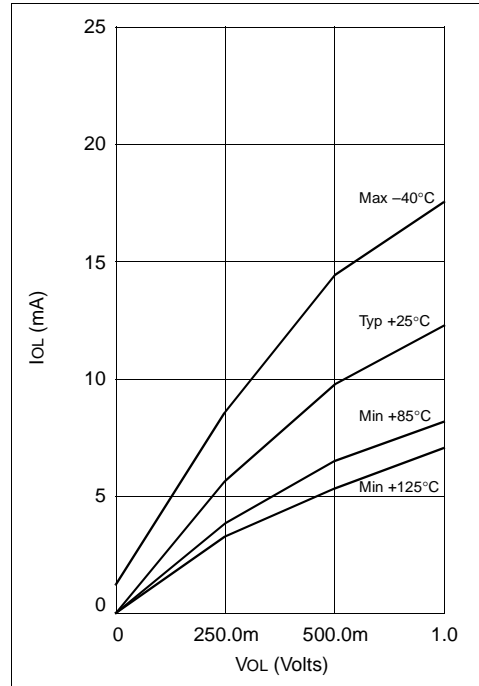
V <sub>DD</sub> (Volts)	Temperature (°C)	Min	Typ	Max	Units
GP0/GP1					
2.5	–40	38K	42K	63K	Ω
	25	42K	48K	63K	Ω
	85	42K	49K	63K	Ω
	125	50K	55K	63K	Ω
5.5	–40	15K	17K	20K	Ω
	25	18K	20K	23K	Ω
	85	19K	22K	25K	Ω
	125	22K	24K	28K	Ω
GP3					
2.5	–40	285K	346K	417K	Ω
	25	343K	414K	532K	Ω
	85	368K	457K	532K	Ω
	125	431K	504K	593K	Ω
5.5	–40	247K	292K	360K	Ω
	25	288K	341K	437K	Ω
	85	306K	371K	448K	Ω
	125	351K	407K	500K	Ω

\* These parameters are characterized but not tested.

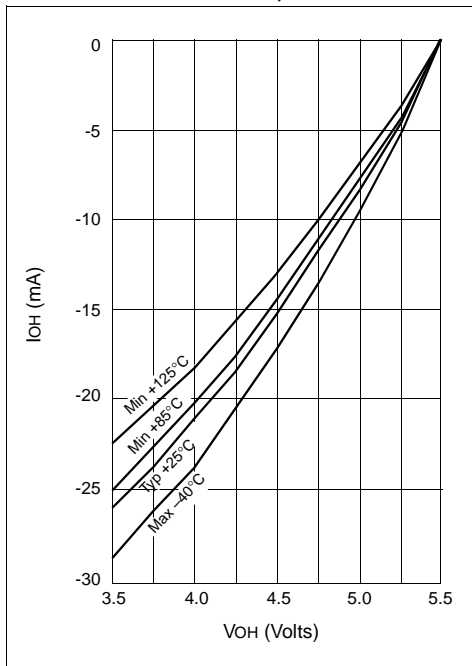
**FIGURE 12-5:  $I_{OH}$  vs.  $V_{OH}$ ,  $V_{DD} = 2.5\text{ V}$**



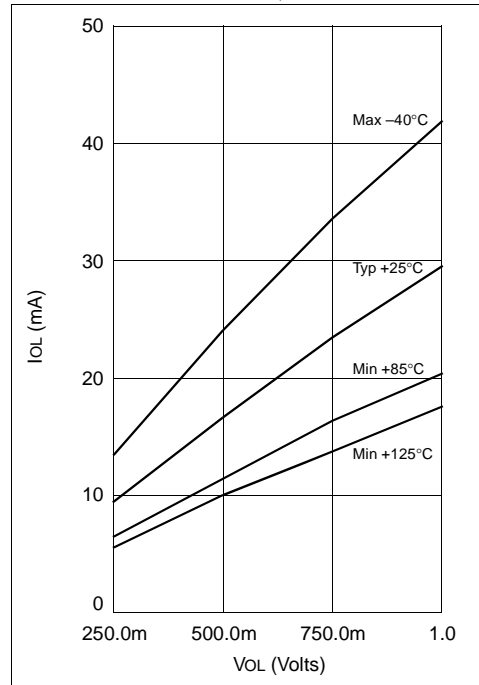
**FIGURE 12-7:  $I_{OL}$  vs.  $V_{OL}$ ,  $V_{DD} = 2.5\text{ V}$**



**FIGURE 12-6:  $I_{OH}$  vs.  $V_{OH}$ ,  $V_{DD} = 5.5\text{ V}$**



**FIGURE 12-8:  $I_{OL}$  vs.  $V_{OL}$ ,  $V_{DD} = 5.5\text{ V}$**



**TABLE 13-8: EEPROM MEMORY BUS TIMING REQUIREMENTS - PIC12CE5XX ONLY.**

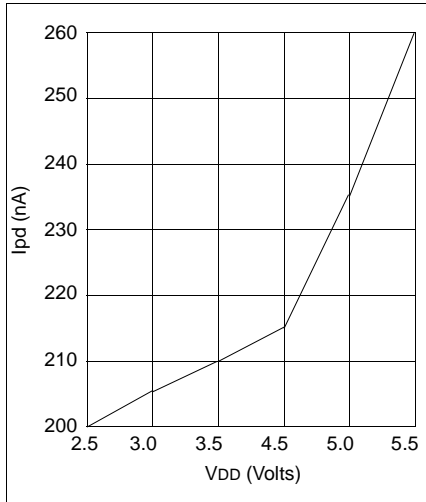
AC Characteristics	Standard Operating Conditions (unless otherwise specified)				
	Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ , $V_{CC} = 3.0\text{V}$ to $5.5\text{V}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ , $V_{CC} = 3.0\text{V}$ to $5.5\text{V}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ , $V_{CC} = 4.5\text{V}$ to $5.5\text{V}$ (extended) Operating Voltage $V_{DD}$ range is described in Section 13.1				
Parameter	Symbol	Min	Max	Units	Conditions
Clock frequency	FCLK	—	100	kHz	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		—	100		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		—	400		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Clock high time	T <sub>HIGH</sub>	4000	—	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		4000	—		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		600	—		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Clock low time	T <sub>LOW</sub>	4700	—	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		4700	—		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		1300	—		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
SDA and SCL rise time (Note 1)	T <sub>R</sub>	—	1000	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		—	1000		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		—	300		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
SDA and SCL fall time	T <sub>F</sub>	—	300	ns	(Note 1)
START condition hold time	T <sub>HD:STA</sub>	4000	—	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		4000	—		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		600	—		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
START condition setup time	T <sub>SU:STA</sub>	4700	—	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		4700	—		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		600	—		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Data input hold time	T <sub>HD:DAT</sub>	0	—	ns	(Note 2)
Data input setup time	T <sub>SU:DAT</sub>	250	—	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		250	—		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		100	—		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
STOP condition setup time	T <sub>SU:STO</sub>	4000	—	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		4000	—		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		600	—		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Output valid from clock (Note 2)	T <sub>AA</sub>	—	3500	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		—	3500		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		—	900		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Bus free time: Time the bus must be free before a new transmis- sion can start	T <sub>BUF</sub>	4700	—	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range)
		4700	—		$3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$
		1300	—		$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Output fall time from V <sub>IH</sub> minimum to V <sub>IL</sub> maximum	T <sub>oF</sub>	20+0.1 CB	250	ns	(Note 1), CB $\leq$ 100 pF
Input filter spike suppression (SDA and SCL pins)	T <sub>SP</sub>	—	50	ns	(Notes 1, 3)
Write cycle time	T <sub>WC</sub>	—	4	ms	
Endurance		1M	—	cycles	25°C, V <sub>CC</sub> = 5.0V, Block Mode (Note 4)

**Note 1:** Not 100% tested. CB = total capacitance of one bus line in pF.

- As a transmitter, the device must provide an internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.
- The combined T<sub>SP</sub> and V<sub>HYS</sub> specifications are due to new Schmitt trigger inputs which provide improved noise spike suppression. This eliminates the need for a TI specification for standard operation.
- This parameter is not tested but guaranteed by characterization. For endurance estimates in a specific application, please consult the Total Endurance Model which can be obtained on Microchip's website.



**FIGURE 14-13: TYPICAL IPD VS. VDD,  
WATCHDOG DISABLED (25°C)**



**FIGURE 14-14: VTH (INPUT THRESHOLD  
VOLTAGE) OF GPIO PINS  
VS. VDD**

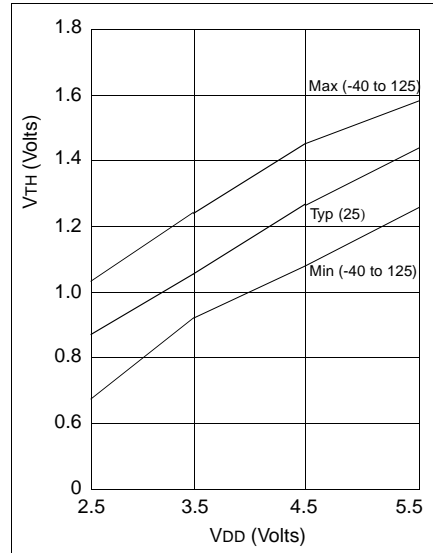
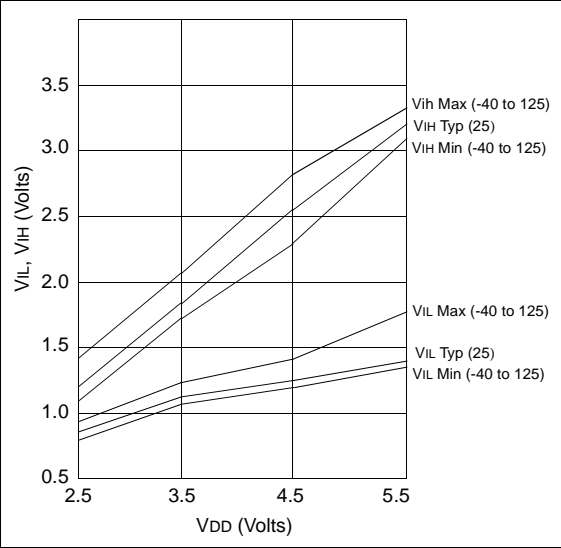


FIGURE 14-15: VIL, VIH OF NMCLR, AND T0CKI VS. VDD





## PIC12C5XX Product Identification System

PART NO.	-XX	X	/XX	XXX			Examples
					<b>Pattern:</b>	Special Requirements	a) PIC12C508A-04/P Commercial Temp., PDIP Package, 4 MHz, normal VDD limits
					<b>Package:</b>	SN = 150 mil SOIC SM = 208 mil SOIC P = 300 mil PDIP JW = 300 mil Windowed Ceramic Side Brazed	b) PIC12C508A-04I/SM Industrial Temp., SOIC package, 4 MHz, normal VDD limits
					<b>Temperature Range:</b>	- = 0°C to +70°C I = -40°C to +85°C E = -40°C to +125°C	c) PIC12C509-04I/P Industrial Temp., PDIP package, 4 MHz, normal VDD limits
					<b>Frequency Range:</b>	04 = 4 MHz	
					<b>Device</b>	PIC12C508 PIC12C509 PIC12C508T (Tape & reel for SOIC only) PIC12C509T (Tape & reel for SOIC only) PIC12C508A PIC12C509A PIC12C508AT (Tape & reel for SOIC only) PIC12C509AT (Tape & reel for SOIC only) PIC12LC508A PIC12LC509A PIC12LC508AT (Tape & reel for SOIC only) PIC12LC509AT (Tape & reel for SOIC only) PIC12CR509A PIC12CR509AT (Tape & reel for SOIC only) PIC12LCR509A PIC12LCR509AT (Tape & reel for SOIC only) PIC12CE518 PIC12CE518T (Tape & reel for SOIC only) PIC12CE519 PIC12CE519T (Tape & reel for SOIC only) PIC12LCE518 PIC12LCE518T (Tape & reel for SOIC only) PIC12LCE519 PIC12LCE519T (Tape & reel for SOIC only)	

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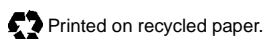
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